

Chopper-Stabilized Unipolar Hall-Effect Switches

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Chopper-Stabilized Unipolar Hall-Effect Switches

Features and Benefits

- Chopper stabilization
	- Superior temperature stability
	- Extremely low switchpoint drift
	- Insensitive to physical stress
- Reverse battery protection
- Output short circuit protection
- Solid state reliability
- Small size
- Robust EMC capability
- High ESD ratings (HBM)

Packages: 3 pin SOT23W (suffix LH), and 3 pin SIP (suffix UA)

Not to scale

Description

The A3241 and A3242 integrated circuits are unipolar Halleffect switches with digital outputs. These devices are suited for operation over extended temperature ranges, up to $+150^{\circ}$ C. Superior high-temperature performance is made possible through an Allegro[®] dynamic offset cancellation, which reduces the residual offset voltage normally caused by device overmolding, temperature excursions, and thermal stress.

The A3241 and A3242 Hall-effect switches include the following on a single silicon chip: voltage regulator, Hallvoltage generator, small-signal amplifier, chopper stabilization, Schmitt trigger, and a short circuit protected open-drain output. Advanced BiCMOS wafer fabrication processing is used to take advantage of low-voltage requirements, component matching, very low input-offset errors, and small component geometries.

The integrated voltage regulator permits operation from 3.6 to 24 V. The unipolar family members operate with a sufficient south polarity field only, turning off in the absence of such a south polarity field.

Continued on the next page…

Functional Block Diagram

Description (continued)

The A3241 and A3242 are rated for operation between the ambient temperatures -40° C and 85° C for the E temperature range, and -40° C to 150°C for the L temperature range. The small geometries of the BiCMOS process allow these devices to be provided in ultrasmall packages. The package styles available provide magnetically

optimized solutions for most applications. Package LH is an SOT23W, a miniature low-profile surface-mount package, while package UA is a three-lead ultramini SIP for through-hole mounting. Each package is lead (Pb) free, with 100% matte tin plated leadframes.

Selection Guide

¹Contact Allegro for additional packing options.

2This device is in production, however, it has been deemed Pre-End of Life. The product is approaching end of life. Within a minimum of 6 months, the device will enter its final, Last Time Buy, order phase. Status change: August 16, 2010. Recommended substitution: A1122.

Absolute Maximum Ratings

Chopper-Stabilized Unipolar Hall Effect Switches **A3241 and**

OPERATING CHARACTERISTICS valid over full operating voltage and ambient temperature ranges, unless otherwise noted

mum voltage must be adjusted for power dissipation and junction temperature, see *Power Derating* section.

 $2 C_S$ = oscilloscope probe capacitance.

³ Maximum current limit is equal to the maximum $I_{\text{CC}(MAX)} + 3$ mA.

4 Magnetic flux density, B, is indicated as a negative value for north-polarity magnetic fields, and as a positive value for south-polarity magnetic fields. This so-called algebraic convention supports arithmetic comparison of north and south polarity values, where the relative strength of the field is indicated by the absolute value of B, and the sign indicates the polarity of the field (for example, a -100 G field and a 100 G field have equivalent strength, but opposite polarity).

DEVICE QUALIFICATION PROGRAM Contact Allegro for information.

EMC (Electromagnetic Compatibility) REQUIREMENTS Contact Allegro for information.

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Characteristic Data

Continued on the next page...

THERMAL CHARACTERISTICS may require derating at maximum conditions, see application information

Power Derating Curve

Chopper-Stabilized Unipolar Hall Effect Switches **A3241 and**

Functional Description

Operation

The output of these devices switches low (turns on) when a magnetic field (south polarity) perpendicular to the Hall element exceeds the operate point threshold, B_{OP} . After turn-on, the output voltage is $V_{\text{OUT(SAT)}}$. The output transistor is capable of sinking current up to the short circuit current limit, I_{OM} , which is a minimum of 30 mA. When the magnetic field is reduced below the release point, B_{RP} , the device output goes high (turns off). The difference in the magnetic operate and release points is the hysteresis, B_{hvs} , of the device. This built-in hysteresis allows clean switching of the output even in the presence of external mechanical vibration and electrical noise.

Powering-on the device in the hysteresis region, less than B_{OP} and higher than B_{RP} , allows an indeterminate output state. The correct state is attained after the first excursion beyond B_{OP} or B_{RP} .

Applications

It is strongly recommended that an external bypass capacitor be connected (in close proximity to the Hall element) between the supply and ground of the device to reduce both external noise and noise generated by the chopper stabilization technique. As is shown in Panel B of figure 1, a 0.1μ F capacitor is typical.

Extensive applications information on magnets and Hall-effect devices is available in:

- ï *Hall-Effect IC Applications Guide*, AN27701,
- ï *Hall-Effect Devices: Gluing, Potting, Encapsulating, Lead Welding and Lead Forming*, AN27703.1
- Soldering Methods for Allegro's Products SMT and Through-*Hole*, AN26009

All are provided in *Allegro Electronic Data Book*, AMS-702 and the Allegro Web site: www.allegromicro.com

Figure 1: Switching Behavior of Unipolar Switches. In Panel A, *on the horizontal axis, the B+ direction indicates increasing south polarity* magnetic field strength, and the B- direction indicates decreasing south polarity field strength (including the case of increasing north *polarity). This behavior can be exhibited when using a circuit such as that shown in panel B.*

Chopper Stabilization Technique

When using Hall-effect technology, a limiting factor for switchpoint accuracy is the small signal voltage developed across the Hall element. This voltage is disproportionally small relative to the offset that can be produced at the output of the Hall element. This makes it difficult to process the signal while maintaining an accurate, reliable output over the specified operating temperature and voltage ranges.

Chopper stabilization is a unique approach used to minimize Hall offset on the chip. The Allegro technique, namely Dynamic Quadrature Offset Cancellation, removes key sources of the output drift induced by thermal and mechanical stresses. This offset reduction technique is based on a signal modulationdemodulation process. The undesired offset signal is separated from the magnetic-field-induced signal in the frequency domain, through modulation. The subsequent demodulation acts as a modulation process for the offset, causing the magnetic-fieldinduced signal to recover its original spectrum at baseband, while the DC offset becomes a high-frequency signal. The magnetic-feld-induced signal then can pass through a low-pass flter, while the modulated DC offset is suppressed. This configuration is illustrated in figure 2.

The chopper stabilization technique uses a 200 kHz high-frequency clock. For demodulation process, a sample and hold technique is used, where the sampling is performed at twice the chopper frequency (400 kHz). This high-frequency operation allows a greater sampling rate, which results in higher accuracy and faster signal-processing capability. This approach desensitizes the chip to the effects of thermal and mechanical stresses, and produces devices that have extremely stable quiescent Hall output voltages and precise recoverability after temperature cycling. This technique is made possible through the use of a BiCMOS process, which allows the use of low-offset, low-noise amplifiers in combination with high-density logic integration and sample-and-hold circuits.

The repeatability of magnetic-field-induced switching is affected slightly by a chopper technique. However, the Allegro highfrequency chopping approach minimizes the affect of jitter and makes it imperceptible in most applications. Applications that are more likely to be sensitive to such degradation are those requiring precise sensing of alternating magnetic fields; for example, speed sensing of ring-magnet targets. For such applications, Allegro recommends its digital device families with lower sensitivity to jitter. For more information on those devices, contact your Allegro sales representative.

Figure 2. Chopper Stabilization Circuit (Dynamic Quadrature Offset Cancellation)

Power Derating

The device must be operated below the maximum junction temperature of the device, $T_{J(max)}$. Under certain combinations of peak conditions, reliable operation may require derating supplied power or improving the heat dissipation properties of the application. This section presents a procedure for correlating factors affecting operating T_J . (Thermal data is also available on the Allegro MicroSystems Web site.)

The Package Thermal Resistance, $R_{\theta JA}$, is a figure of merit summarizing the ability of the application and the device to dissipate heat from the junction (die), through all paths to the ambient air. Its primary component is the Effective Thermal Conductivity, K, of the printed circuit board, including adjacent devices and traces. Radiation from the die through the device case, $R_{\theta IC}$, is relatively small component of R_{0JA} . Ambient air temperature, T_A , and air motion are significant external factors, damped by overmolding.

The effect of varying power levels (Power Dissipation, P_D), can be estimated. The following formulas represent the fundamental relationships used to estimate T_J , at P_D .

$$
P_{D} = V_{IN} \times I_{IN}
$$
 (1)

$$
\Delta T = P_{D} \times R_{0JA}
$$
 (2)

$$
T_{J} = T_{A} + \Delta T
$$
 (3)

For example, given common conditions such as: $T_A = 25^{\circ}C$, V_{CC} = 12 V, I_{CC} = 1.5 mA, and R_{0JA} = 165 °C/W, then:

$$
P_D = V_{CC} \times I_{CC} = 12 \text{ V} \times 1.5 \text{ mA} = 18 \text{ mW}
$$

 $\Delta T = P_D \times R_{\theta JA} = 18$ mW $\times 165$ °C/W = 3°C

 $T_J = T_A + \Delta T = 25$ °C + 3°C = 28°C

A worst-case estimate, $P_{D(max)}$, represents the maximum allowable power level ($V_{CC(max)}$, $I_{CC(max)}$), without exceeding $T_{J(max)}$, at a selected $R_{\theta JA}$ and T_A .

Example: Reliability for V_{CC} at $T_A = 150^{\circ}C$, package LH, using a low-K PCB.

Observe the worst-case ratings for the device, specifically: $R_{0JA} = 228$ °C/W, $T_{J(max)} = 165$ °C, $V_{CC(max)} = 24$ V, and $I_{\text{CC(max)}} = 5 \text{ mA}.$

Calculate the maximum allowable power level, $P_{D(max)}$. First, invert equation 3:

$$
\Delta T_{\text{max}} = T_{\text{J(max)}} - T_{\text{A}} = 165 \,^{\circ}\text{C} - 150 \,^{\circ}\text{C} = 15 \,^{\circ}\text{C}
$$

This provides the allowable increase to T_J resulting from internal power dissipation. Then, invert equation 2:

$$
P_{D(max)} = \Delta T_{max} \div R_{\theta JA} = 15\degree C \div 228\degree C/W = 65.8\text{ mW}
$$

Finally, invert equation 1 with respect to voltage:

$$
V_{\text{CC}(\text{est})} = P_{\text{D}(\text{max})} \div I_{\text{CC}(\text{max})} = 65.8 \text{ mW} \div 5 \text{ mA} = 13.2 \text{ V}
$$

The result indicates that, at T_A , the application and device can dissipate adequate amounts of heat at voltages \leq V_{CC(est)}.

Compare $V_{CC(est)}$ to $V_{CC(max)}$. If $V_{CC(est)} \leq V_{CC(max)}$, then reliable operation between $V_{CC(est)}$ and $V_{CC(max)}$ requires enhanced $R_{\theta JA}$. If $V_{CC(est)} \geq V_{CC(max)}$, then operation between $V_{CC(est)}$ and $V_{\text{CC(max)}}$ is reliable under these conditions.

Chopper-Stabilized Unipolar Hall Effect Switches **A3241 and**

Package LH, 3-Pin (SOT-23W)

Chopper-Stabilized Unipolar Hall Effect Switches **A3241 and**

Package UA, 3-Pin SIP

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